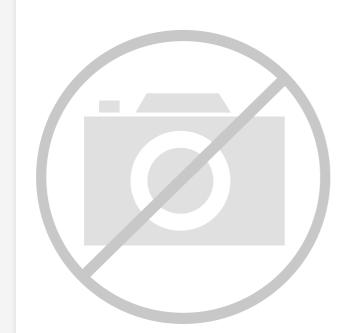
E·XFL

Altera - EPF8820ABC225-4 Datasheet



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Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

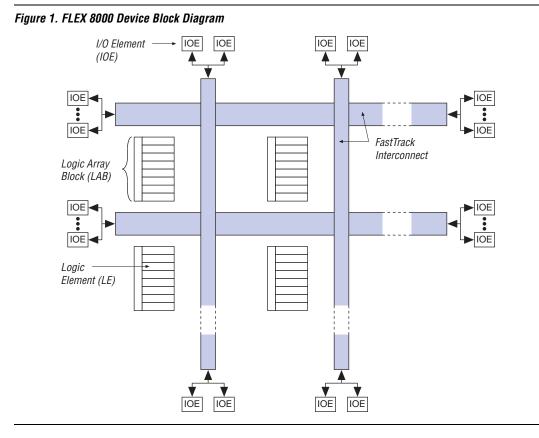
Details

Details	
Product Status	Active
Number of LABs/CLBs	84
Number of Logic Elements/Cells	672
Total RAM Bits	-
Number of I/O	152
Number of Gates	-
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	225-BGA
Supplier Device Package	225-BGA (19x19)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=epf8820abc225-4

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

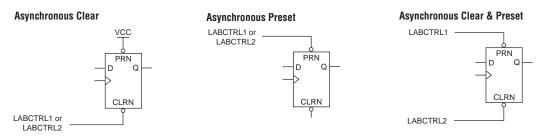
Figure 1 shows a block diagram of the FLEX 8000 architecture. Each group of eight LEs is combined into an LAB; LABs are arranged into rows and columns. The I/O pins are supported by I/O elements (IOEs) located at the ends of rows and columns. Each IOE contains a bidirectional I/O buffer and a flipflop that can be used as either an input or output register.



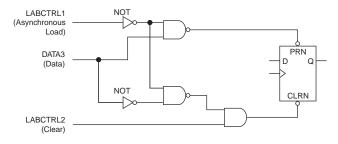
Signal interconnections within FLEX 8000 devices and between device pins are provided by the FastTrack Interconnect, a series of fast, continuous channels that run the entire length and width of the device. IOEs are located at the end of each row (horizontal) and column (vertical) FastTrack Interconnect path.

Altera Corporation

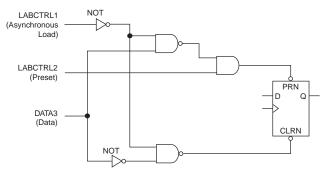
Figure 7. FLEX 8000 LE Asynchronous Clear & Preset Modes



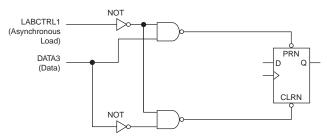
Asynchronous Load with Clear



Asynchronous Load with Preset



Asynchronous Load without Clear or Preset



Asynchronous Clear

A register is cleared by one of the two LABCTRL signals. When the CLRn port receives a low signal, the register is set to zero.

Asynchronous Preset

An asynchronous preset is implemented as either an asynchronous load or an asynchronous clear. If DATA3 is tied to VCC, asserting LABCTRL1 asynchronously loads a 1 into the register. Alternatively, the MAX+PLUS II software can provide preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

Asynchronous Clear & Preset

When implementing asynchronous clear and preset, LABCTRL1 controls the preset and LABCTRL2 controls the clear. The DATA3 input is tied to VCC; therefore, asserting LABCTRL1 asynchronously loads a 1 into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

Asynchronous Load with Clear

When implementing an asynchronous load with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear.

Asynchronous Load with Preset

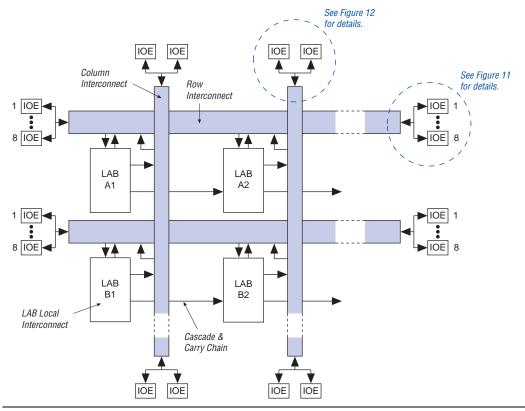
When implementing an asynchronous load in conjunction with a preset, the MAX+PLUS II software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 clears the register, while asserting LABCTRL1 loads the register. The MAX+PLUS II software inverts the signal that drives the DATA3 signal to account for the inversion of the register's output.

Asynchronous Load without Clear or Preset

When implementing an asynchronous load without the clear or preset, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear.

Figure 9. FLEX 8000 Device Interconnect Resources

Each LAB is named according to its physical row (A, B, C, etc.) and column (1, 2, 3, etc.) position within the device.



I/O Element

An IOE contains a bidirectional I/O buffer and a register that can be used either as an input register for external data that requires a fast setup time, or as an output register for data that requires fast clock-to-output performance. IOEs can be used as input, output, or bidirectional pins. The MAX+PLUS II Compiler uses the programmable inversion option to automatically invert signals from the row and column interconnect where appropriate. Figure 10 shows the IOE block diagram.

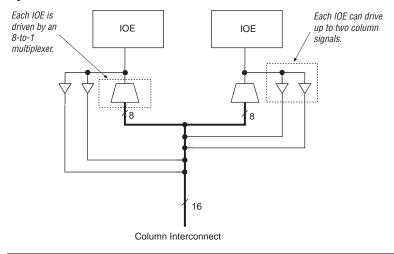


Figure 12. FLEX 8000 Column-to-IOE Connections

In addition to general-purpose I/O pins, FLEX 8000 devices have four dedicated input pins. These dedicated inputs provide low-skew, device-wide signal distribution, and are typically used for global clock, clear, and preset control signals. The signals from the dedicated inputs are available as control signals for all LABs and I/O elements in the device. The dedicated inputs can also be used as general-purpose data inputs because they can feed the local interconnect of each LAB in the device.

Signals enter the FLEX 8000 device either from the I/O pins that provide general-purpose input capability or from the four dedicated inputs. The IOEs are located at the ends of the row and column interconnect channels.

I/O pins can be used as input, output, or bidirectional pins. Each I/O pin has a register that can be used either as an input register for external data that requires fast setup times, or as an output register for data that requires fast clock-to-output performance. The MAX+PLUS II Compiler uses the programmable inversion option to invert signals automatically from the row and column interconnect when appropriate.

The clock, clear, and output enable controls for the IOEs are provided by a network of I/O control signals. These signals can be supplied by either the dedicated input pins or by internal logic. The IOE control-signal paths are designed to minimize the skew across the device. All control-signal sources are buffered onto high-speed drivers that drive the signals around the periphery of the device. This "peripheral bus" can be configured to provide up to four output enable signals (10 in EPF81500A devices), and up to two clock or clear signals. Figure 13 on page 22 shows how two output enable signals are shared with one clock and one clear signal.

MultiVolt I/O Interface

The FLEX 8000 device architecture supports the MultiVolt I/O interface feature, which allows EPF81500A, EPF81188A, EPF8820A, and EPF8636A devices to interface with systems with differing supply voltages. These devices in all packages—except for EPF8636A devices in 84-pin PLCC packages—can be set for 3.3-V or 5.0-V I/O pin operation. These devices have one set of V_{CC} pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCINT pins must always be connected to a 5.0-V power supply. With a 5.0-V V_{CCINT} level, input voltages are at TTL levels and are therefore compatible with 3.3-V and 5.0-V inputs.

The VCCIO pins can be connected to either a 3.3-V or 5.0-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 5.0-V power supply, the output levels are compatible with 5.0-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with V_{CCIO} levels lower than 4.75 V incur a nominally greater timing delay of t_{OD2} instead of t_{OD1} . See Table 8 on page 26.

IEEE Std. 1149.1 (JTAG) Boundary-Scan Support

The EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices provide JTAG BST circuitry. FLEX 8000 devices with JTAG circuitry support the JTAG instructions shown in Table 6.

Table 6. EPF8282A,	Table 6. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Instructions					
JTAG Instruction	Description					
SAMPLE/PRELOAD	Allows a snapshot of the signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern to be output at the device pins.					
EXTEST	Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins.					
BYPASS	Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through the selected device to adjacent devices during normal device operation.					

The instruction register length for FLEX 8000 devices is three bits. Table 7 shows the boundary-scan register length for FLEX 8000 devices.

Device Boundary-Scan Register Length EPF8282A, EPF8282AV 273		
Device	Boundary-Scan Register Length	
EPF8282A, EPF8282AV	273	
EPF8636A	417	
EPF8820A	465	
EPF81500A	645	

FLEX 8000 devices that support JTAG include weak pull-ups on the JTAG pins. Figure 14 shows the timing requirements for the JTAG signals.

Figure 14. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Waveforms

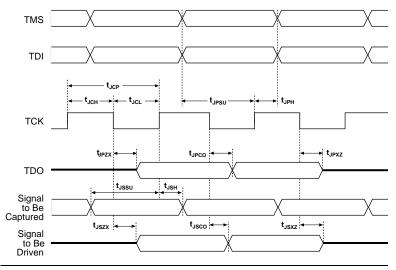


Table 8 shows the timing parameters and values for EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices.

Table 1	Table 12. FLEX 8000 5.0-V Device CapacitanceNote (8)							
Symbol	Parameter	Conditions	Min	Max	Unit			
C _{IN}	Input capacitance	V _{IN} = 0 V, f = 1.0 MHz		10	pF			
C _{OUT}	Output capacitance	V _{OUT} = 0 V, f = 1.0 MHz		10	pF			

Notes to tables:

(1) See the Operating Requirements for Altera Devices Data Sheet.

- (2) Minimum DC input is -0.5 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 7.0 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) The maximum V_{CC} rise time is 100 ms.
- (4) Numbers in parentheses are for industrial-temperature-range devices.
- (5) Typical values are for $T_A = 25^\circ \text{ C}$ and $V_{CC} = 5.0 \text{ V}$.
- (6) These values are specified in Table 10 on page 28.
- (7) The I_{OH} parameter refers to high-level TTL or CMOS output current; the I_{OL} parameter refers to low-level TTL or CMOS output current.
- (8) Capacitance is sample-tested only.

Tables 13 through 16 provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for 3.3-V FLEX 8000 devices.

Table 13. FLEX 8000 3.3-V Device Absolute Maximum Ratings Note (1)						
Symbol	Parameter	Conditions	Min	Max	Unit	
V _{CC}	Supply voltage	With respect to ground (2)	-2.0	5.3	V	
VI	DC input voltage		-2.0	5.3	V	
I _{OUT}	DC output current, per pin		-25	25	mA	
T _{STG}	Storage temperature	No bias	-65	150	°C	
T _{AMB}	Ambient temperature	Under bias	-65	135	°C	
TJ	Junction temperature	Plastic packages, under bias		135	°C	

Table 1	Table 14. FLEX 8000 3.3-V Device Recommended Operating Conditions							
Symbol	Parameter	Conditions	Min	Max	Unit			
V _{CC}	Supply voltage	(3)	3.0	3.6	V			
VI	Input voltage		-0.3	V _{CC} + 0.3	V			
Vo	Output voltage		0	V _{CC}	V			
Τ _Α	Operating temperature	For commercial use	0	70	°C			
t _R	Input rise time			40	ns			
t _F	Input fall time			40	ns			

FLEX 8000 Programmable Logic Device Family Data Sheet

Table 1	Table 15. FLEX 8000 3.3-V Device DC Operating Conditions Note (4)									
Symbol	Parameter	Conditions	Min	Тур	Max	Unit				
V _{IH}	High-level input voltage		2.0		V _{CC} + 0.3	V				
V _{IL}	Low-level input voltage		-0.3		0.8	V				
V _{OH}	High-level output voltage	I _{OH} = -0.1 mA DC <i>(</i> 5 <i>)</i>	$V_{CC} - 0.2$			V				
V _{OL}	Low-level output voltage	I _{OL} = 4 mA DC <i>(</i> 5 <i>)</i>			0.45	V				
I _I	Input leakage current	$V_{I} = V_{CC}$ or ground	-10		10	μA				
I _{OZ}	Tri-state output off-state current	$V_{O} = V_{CC}$ or ground	-40		40	μA				
I _{CC0}	V _{CC} supply current (standby)	V _I = ground, no load (6)		0.3	10	mA				

Table 1	Table 16. FLEX 8000 3.3-V Device Capacitance Note (7)							
Symbol	Parameter	Conditions	Min	Max	Unit			
C _{IN}	Input capacitance	V _{IN} = 0 V, f = 1.0 MHz		10	pF			
C _{OUT}	Output capacitance	V _{OUT} = 0 V, f = 1.0 MHz		10	pF			

Notes to tables:

(1) See the Operating Requirements for Altera Devices Data Sheet.

(2) Minimum DC input voltage is -0.3 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 5.3 V for input currents less than 100 mA and periods shorter than 20 ns.

(3) The maximum V_{CC} rise time is 100 ms. \overline{V}_{CC} must rise monotonically.

(4) These values are specified in Table 14 on page 29.

(5) The I_{OH} parameter refers to high-level TTL output current; the I_{OL} parameter refers to low-level TTL output current.

(6) Typical values are for $T_A = 25^\circ \text{ C}$ and $V_{CC} = 3.3 \text{ V}$.

(7) Capacitance is sample-tested only.

Figure 16 shows the typical output drive characteristics of 5.0-V FLEX 8000 devices. The output driver is compliant with *PCI Local Bus Specification, Revision* 2.2.

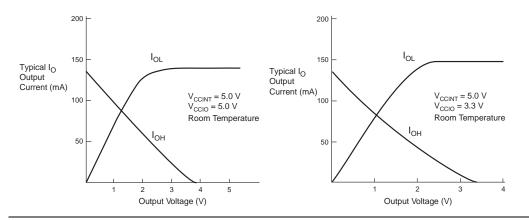
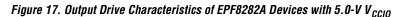


Figure 16. Output Drive Characteristics of 5.0-V FLEX 8000 Devices (Except EPF8282A)

Figure 17 shows the typical output drive characteristics of 5.0-V EPF8282A devices. The output driver is compliant with *PCI Local Bus Specification, Revision 2.2.*



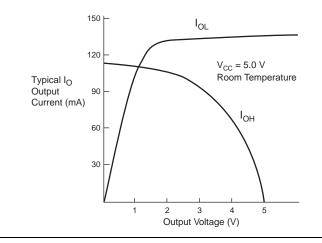


Figure 18 shows the typical output drive characteristics of EPF8282AV devices.

FLEX 8000 Programmable Logic Device Family Data Sheet

Source	Destination	Total Delay	
LE-Out	LE in same LAB	t _{LOCAL}	
LE-Out	LE in same row, different LAB	$t_{ROW} + t_{LOCAL}$	
LE-Out	LE in different row	$t_{COL} + t_{ROW} + t_{LOCAL}$	
LE-Out	IOE on column	t _{COL}	
LE-Out	IOE on row	t _{ROW}	
IOE on row	LE in same row	$t_{ROW} + t_{LOCAL}$	
IOE on column	Any LE	$t_{COL} + t_{ROW} + t_{LOCAL}$	

Tables 22 through 49 show the FLEX 8000 internal and external timing parameters.

Symbol			Speed	Grade			Unit	
	A	-2	A-3		A-4			
	Min	Max	Min	Мах	Min	Max		
t _{IOD}		0.7		0.8		0.9	ns	
t _{IOC}		1.7		1.8		1.9	ns	
t _{IOE}		1.7		1.8		1.9	ns	
t _{IOCO}		1.0		1.0		1.0	ns	
t _{IOCOMB}		0.3		0.2		0.1	ns	
t _{IOSU}	1.4		1.6		1.8		ns	
t _{IOH}	0.0		0.0		0.0		ns	
t _{IOCLR}		1.2		1.2		1.2	ns	
t _{IN}		1.5		1.6		1.7	ns	
t _{OD1}		1.1		1.4		1.7	ns	
t _{OD2}		-		-		-	ns	
t _{OD3}		4.6		4.9		5.2	ns	
t _{XZ}		1.4		1.6		1.8	ns	
t _{ZX1}		1.4		1.6		1.8	ns	
t _{ZX2}		-		-		-	ns	
t _{ZX3}		4.9		5.1		5.3	ns	

Symbol			Speed	Grade			Unit
	A	-2	A-3		A-4		
	Min	Max	Min	Мах	Min	Мах	
t _{LUT}		2.0		2.5		3.2	ns
t _{CLUT}		0.0		0.0		0.0	ns
t _{RLUT}		0.9		1.1		1.5	ns
t _{GATE}		0.0		0.0		0.0	ns
t _{CASC}		0.6		0.7		0.9	ns
t _{CICO}		0.4		0.5		0.6	ns
t _{CGEN}		0.4		0.5		0.7	ns
t _{CGENR}		0.9		1.1		1.5	ns
t _C		1.6		2.0		2.5	ns
t _{CH}	4.0		4.0		4.0		ns
t _{CL}	4.0		4.0		4.0		ns
t _{CO}		0.4		0.5		0.6	ns
t _{COMB}		0.4		0.5		0.6	ns
t _{SU}	0.8		1.1		1.2		ns
t _H	0.9		1.1		1.5		ns
t _{PRE}		0.6		0.7		0.8	ns
t _{CLR}		0.6		0.7		0.8	ns

Table 25. EPF8282A External Timing Parameters

Symbol	Speed Grade						
	A-2		A-3		A-	A-4	
	Min	Max	Min	Max	Min	Мах	
t _{DRR}		15.8		19.8		24.8	ns
t _{ODH}	1.0		1.0		1.0		ns

FLEX 8000 Programmable Logic Device Family Data Sheet	t
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Symbol	Speed Grade							
-	A-3		A	-4	1			
	Min	Max	Min	Мах				
t _{IOD}		0.9		2.2	ns			
tioc		1.9		2.0	ns			
t _{IOE}		1.9		2.0	ns			
tioco		1.0		2.0	ns			
tiocoмв		0.1		0.0	ns			
tiosu	1.8		2.8		ns			
^t іон	0.0		0.2		ns			
tioclr		1.2		2.3	ns			
t _{IN}		1.7		3.4	ns			
t _{OD1}		1.7		4.1	ns			
t _{OD2}		-		-	ns			
tod3		5.2		7.1	ns			
t _{XZ}		1.8		4.3	ns			
ZX1		1.8		4.3	ns			
ZX2		_		-	ns			
t _{ZX3}		5.3		8.3	ns			

Symbol		Speed Grade							
-	A	-3	A	-4					
	Min	Мах	Min	Max					
t _{LABCASC}		0.4		1.3	ns				
t _{LABCARRY}		0.4		0.8	ns				
t _{LOCAL}		0.8		1.5	ns				
t _{ROW}		4.2		6.3	ns				
t _{COL}		2.5		3.8	ns				
t _{DIN_C}		5.5		8.0	ns				
t _{DIN_D}		7.2		10.8	ns				
t _{DIN IO}		5.5		9.0	ns				

Symbol	Speed Grade								
	A-2		A	A-3		-4	1		
	Min	Max	Min	Max	Min	Max			
t _{IOD}		0.7		0.8		0.9	ns		
t _{IOC}		1.7		1.8		1.9	ns		
t _{IOE}		1.7		1.8		1.9	ns		
t _{IOCO}		1.0		1.0		1.0	ns		
t _{IOCOMB}		0.3		0.2		0.1	ns		
t _{IOSU}	1.4		1.6		1.8		ns		
t _{IOH}	0.0		0.0		0.0		ns		
t _{IOCLR}		1.2		1.2		1.2	ns		
t _{IN}		1.5		1.6		1.7	ns		
t _{OD1}		1.1		1.4		1.7	ns		
t _{OD2}		1.6		1.9		2.2	ns		
t _{OD3}		4.6		4.9		5.2	ns		
t _{XZ}		1.4		1.6		1.8	ns		
t _{ZX1}		1.4		1.6		1.8	ns		
t _{ZX2}		1.9		2.1		2.3	ns		
t _{ZX3}		4.9		5.1		5.3	ns		

Symbol		Speed Grade								
	A-2		A	-3	A-4		1			
	Min	Max	Min	Max	Min	Max	-			
t _{LABCASC}		0.3		0.4		0.4	ns			
t _{LABCARRY}		0.3		0.4		0.4	ns			
t _{LOCAL}		0.5		0.5		0.7	ns			
t _{ROW}		5.0		5.0		5.0	ns			
t _{COL}		3.0		3.0		3.0	ns			
t _{DIN_C}		5.0		5.0		5.5	ns			
t _{DIN_D}		7.0		7.0		7.5	ns			
t _{DIN_IO}		5.0		5.0		5.5	ns			

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Symbol	Speed Grade								
	A-2		A	A-3		A-4			
	Min	Max	Min	Max	Min	Max			
t _{LUT}		2.0		2.5		3.2	ns		
t _{CLUT}		0.0		0.0		0.0	ns		
t _{RLUT}		0.9		1.1		1.5	ns		
t _{GATE}		0.0		0.0		0.0	ns		
t _{CASC}		0.6		0.7		0.9	ns		
t _{CICO}		0.4		0.5		0.6	ns		
t _{CGEN}		0.4		0.5		0.7	ns		
t _{CGENR}		0.9		1.1		1.5	ns		
t _C		1.6		2.0		2.5	ns		
t _{CH}	4.0		4.0		4.0		ns		
t _{CL}	4.0		4.0		4.0		ns		
t _{CO}		0.4		0.5		0.6	ns		
t _{COMB}		0.4		0.5		0.6	ns		
t _{SU}	0.8		1.1		1.2		ns		
t _H	0.9		1.1		1.5		ns		
t _{PRE}		0.6		0.7		0.8	ns		
t _{CLR}		0.6		0.7		0.8	ns		

Table 41. EPF882	20A External T	iming Parame	ters							
Symbol		Speed Grade								
	A	A-2		A-3		A-4				
	Min	Max	Min	Max	Min	Max	1			
t _{DRR}		16.0		20.0		25.0	ns			
t _{ODH}	1.0		1.0		1.0		ns			

Symbol	Speed Grade								
	A-2		A-3		A-4				
	Min	Мах	Min	Мах	Min	Max			
t _{LUT}		2.0		2.5		3.2	ns		
t _{CLUT}		0.0		0.0		0.0	ns		
t _{RLUT}		0.9		1.1		1.5	ns		
t _{GATE}		0.0		0.0		0.0	ns		
t _{CASC}		0.6		0.7		0.9	ns		
t _{CICO}		0.4		0.5		0.6	ns		
t _{CGEN}		0.4		0.5		0.7	ns		
t _{CGENR}		0.9		1.1		1.5	ns		
t _C		1.6		2.0		2.5	ns		
t _{CH}	4.0		4.0		4.0		ns		
t _{CL}	4.0		4.0		4.0		ns		
t _{CO}		0.4		0.5		0.6	ns		
t _{COMB}		0.4		0.5		0.6	ns		
t _{SU}	0.8		1.1		1.2		ns		
t _H	0.9		1.1		1.5		ns		
t _{PRE}		0.6		0.7		0.8	ns		
t _{CLR}		0.6		0.7		0.8	ns		

Symbol		Speed Grade							
	A	-2	A	-3	A	-4			
	Min	Max	Min	Max	Min	Max	1		
t _{DRR}		16.0		20.0		25.0	ns		
t _{ODH}	1.0		1.0		1.0		ns		

Operating Modes

The FLEX 8000 architecture uses SRAM elements that require configuration data to be loaded whenever the device powers up and begins operation. The process of physically loading the SRAM programming data into the device is called *configuration*. During initialization, which occurs immediately after configuration, the device resets registers, enables I/O pins, and begins to operate as a logic device. The I/O pins are tri-stated during power-up, and before and during configuration. The configuration and initialization processes together are called *command mode*; normal device operation is called *user mode*.

SRAM elements allow FLEX 8000 devices to be reconfigured in-circuit with new programming data that is loaded into the device. Real-time reconfiguration is performed by forcing the device into command mode with a device pin, loading different programming data, reinitializing the device, and resuming user-mode operation. The entire reconfiguration process requires less than 100 ms and can be used to dynamically reconfigure an entire system. In-field upgrades can be performed by distributing new configuration files.

Configuration Schemes

The configuration data for a FLEX 8000 device can be loaded with one of six configuration schemes, chosen on the basis of the target application. Both active and passive schemes are available. In the active configuration schemes, the FLEX 8000 device functions as the controller, directing the loading operation, controlling external configuration devices, and completing the loading process. The clock source for all active configuration schemes is an oscillator on the FLEX 8000 device that operates between 2 MHz and 6 MHz. In the passive configuration schemes, an external controller guides the FLEX 8000 device. Table 51 shows the data source for each of the six configuration schemes.

Table 51. Data Source for Configura	Table 51. Data Source for Configuration								
Configuration Scheme	Acronym	Data Source							
Active serial	AS	Altera configuration device							
Active parallel up	APU	Parallel configuration device							
Active parallel down	APD	Parallel configuration device							
Passive serial	PS	Serial data path							
Passive parallel synchronous	PPS	Intelligent host							
Passive parallel asynchronous	PPA	Intelligent host							

Table 52. FLE	X 8000 84-, 100)-, 144- & 160)-Pin Package	Pin-Outs (Pa	art 2 of 3)		
Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)
ADD0	78	76	78	77	106	N3	6
data7	3	2	90	89	131	P8	140
DATA6	4	4	91	91	132	P10	139
DATA5	6	6	92	95	133	R12	138
DATA4	7	7	95	96	134	R13	136
DATA3	8	8	97	97	135	P13	135
DATA2	9	9	99	98	137	R14	133
DATA1	13	13	4	4	138	N15	132
DATA0	14	14	5	5	140	K13	129
SDOUT (3)	79	78	79	79	23	P4	97
TDI (4)	55	45 (5)	54	-	96	-	17
TDO (4)	27	27 (5)	18	-	18	-	102
TCK (4), (6)	72	44 (5)	72	-	88	_	27
TMS (4)	20	43 (5)	11	-	86	-	29
TRST (7)	52	52 (8)	50	-	71	-	45
Dedicated Inputs (10)	12, 31, 54, 73	12, 31, 54, 73	3, 23, 53, 73	3, 24, 53, 74	9, 26, 82, 99	C3, D14, N2, R15	14, 33, 94, 113
VCCINT	17, 38, 59, 80	17, 38, 59, 80	6, 20, 37, 56, 70, 87	9, 32, 49, 59, 82	8, 28, 70, 90, 111	B2, C4, D3, D8, D12, G3, G12, H4, H13, J3, J12, M4, M7, M9, M13, N12	3, 24, 46, 92, 114, 160
VCCIO	-	-	-	-	16, 40, 60, 69, 91, 112, 122, 141	-	23, 47, 57, 69, 79, 104, 127, 137, 149, 159

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Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF81188A <i>(1)</i>
nSP (2)	120	1	R15	207	207	5
	120	3	T15	4	4	5 21
MSELO (2)	-	38	T3	49	4	
MSEL1 (2)	84 37	83	B3	49 108	49 108	33 124
nSTATUS (2)						
nCONFIG (2)	40	81	C3	103	103	107
DCLK (2)	1	120	C15	158	158	154
CONF_DONE (2)	4	118	B15	153	153	138
n₩S	30	89	C5	114	114	118
nRS	71	50	B5	66	116	121
RDCLK	73	48	C11	64	137	137
nCS	29	91	B13	116	145	142
CS	27	93	A16	118	148	144
RDYnBUSY	125	155	A8	201	127	128
CLKUSR	76	44	A10	59	134	134
ADD17	78	43	R5	57	43	46
ADD16	91	33	U3	43	42	45
ADD15	92	31	T5	41	41	44
ADD14	94	29	U4	39	40	39
ADD13	95	27	R6	37	39	37
ADD12	96	24	T6	31	35	36
ADD11	97	23	R7	30	33	31
ADD10	98	22	T7	29	31	30
ADD9	99	21	Т8	28	29	29
ADD8	101	20	U9	24	25	26
ADD7	102	19	U10	23	23	25
ADD6	103	18	U11	22	21	24
ADD5	104	17	U12	21	19	18
ADD4	105	13	R12	14	14	17
ADD3	106	11	U14	12	13	16
ADD2	109	9	U15	10	11	10
ADD1	110	7	R13	8	10	9
ADD0	123	157	U16	203	9	8
DATA7	144	137	H17	178	178	177
DATA6	150	132	G17	172	176	175
DATA5	152	129	F17	169	174	172

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Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
DATA4	A5	C7	198	194	W16	248
data3	B5	D7	196	193	W17	246
DATA2	E6	B5	194	190	V16	243
DATA1	D5	A3	191	189	U16	241
DATA0	C4	A2	189	187	V17	239
SDOUT (3)	K1	N2	135	136	F19	169
TDI	F15 (4)	-	-	63 (14)	B1 (14)	80 (14)
TDO	J2 (4)	-	-	117	C17	149
тск <i>(6)</i>	J14 <i>(4)</i>	-	-	116 (14)	A19 (14)	148 (14)
TMS	J12 <i>(4)</i>	-	-	64 (14)	C2 (14)	81 (14)
TRST (7)	P14	-	-	115 (14)	A18 (14)	145 (14)
Dedicated Inputs (10)	F4, L1, K12, E15	C1, C17, R1, R17	10, 51, 130, 171	8, 49, 131, 172	F1, F16, P3, P19	12, 64, 164, 217
VCCINT (5.0 V)	F5, F10, E1, L2, K4, M12, P15, H13, H14, B15, C13	E4, H4, L4, P12, L14, H14, E14, R14, U1	20, 42, 64, 66, 114, 128, 150, 172, 236	18, 40, 60, 62, 91, 114, 129, 151, 173, 209, 236	E8, E10, E12,	24, 54, 77, 144, 79, 115, 162, 191, 218 266, 301
VCCIO (5.0 V or 3.3 V)	H3, H2, P6, R6, P10, N10, R14, N13, H15, H12, D12, A14, B10, A10, B6, C6, A2, C3, M4, R2	N10, M13, M5, K13, K5, H13, H5, F5, E10, E8, N8, F13	19, 41, 65, 81, 99, 116, 140, 162, 186, 202, 220, 235	17, 39, 61, 78, 94, 108, 130, 152, 174, 191, 205, 221, 235	D14, E7, E9, E11, E13, R6, R8, R10, R12, T13, T15	